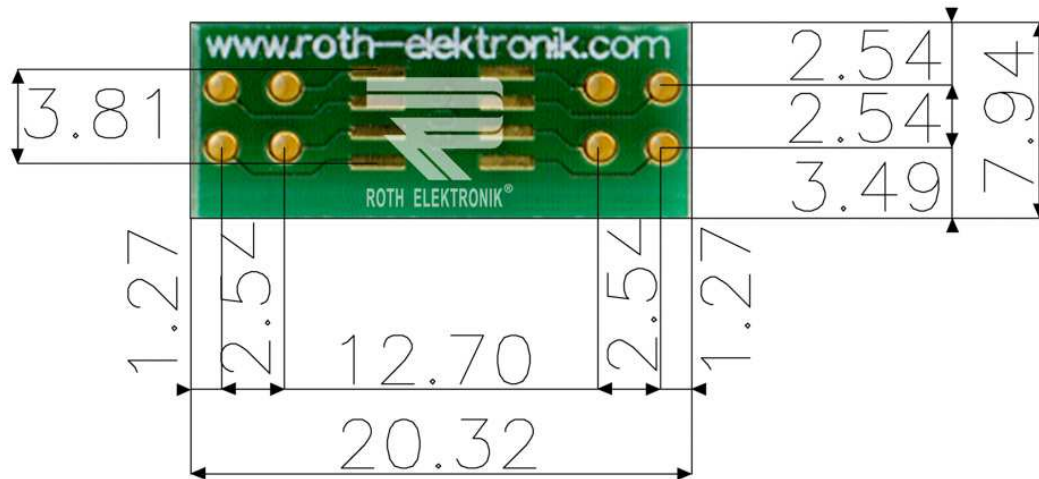


RE932-01

- Epoxy fibre-glass FR4 1.50 mm
- Double-sided 35 µm Cu
- Plated through holes (PTH)
- Surface chem. Ni/Au with solder stop mask
- Adaption circuit board for SO 8
- Pitch: 1.27 mm (153 mil)
- Hole diameter 1.00 mm
- Size 20.32 x 7.94 mm

Module-No. Pitch mil Pin Size (mm)

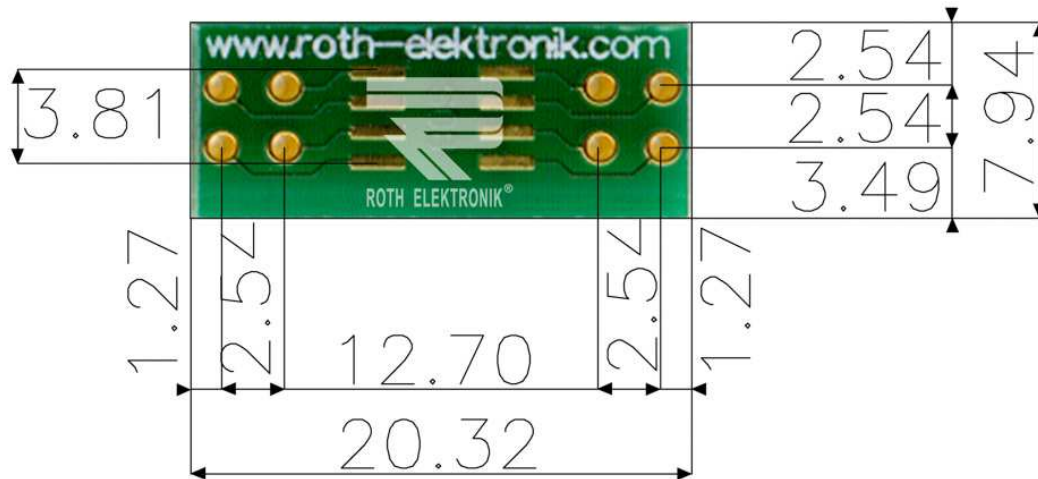
RE932-01 1.270 mm 0,50 8 3.90 (153 mil)



RE932-01

- Epoxydglashartgewebe FR4 1,50 mm
 - Zweiseitig 35 µm Cu
 - Durchkontaktiert (PTH)
 - Oberfläche chem. Ni/Au mit Lötstopplack beschichtet
 - Adaptionsplatine für SO 8
 - Pitch: 1,27 mm (153 mil)
 - Lochdurchmesser 1,00 mm
 - Größe 20,32 x 7,94 mm
- Modul-Nr. Pitch mil Pin Größe (mm)

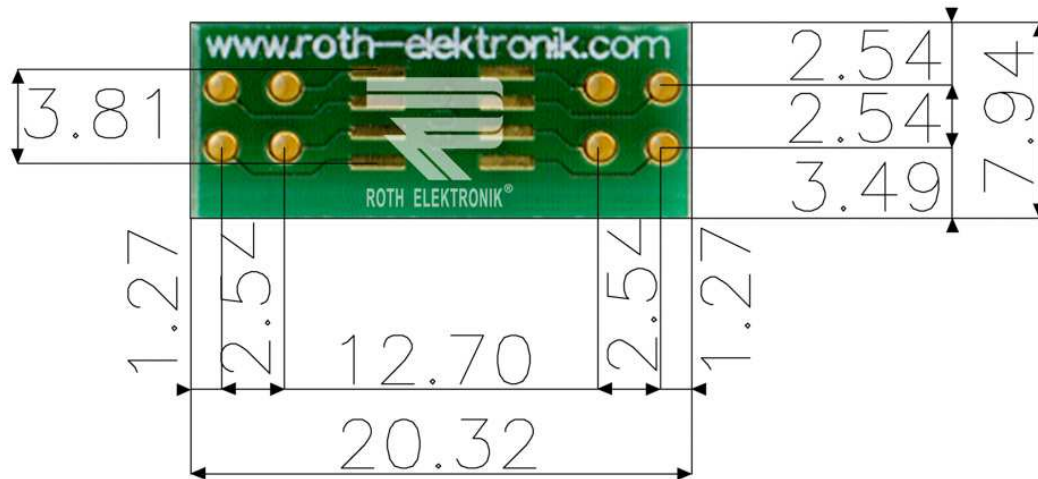
RE932-01 1,270 mm 0,50 8 3,90 (153 mil)



RE932-01

- Fibre de verre époxyde FR4 1,50 mm
 - Double face 35 µm CU
 - Métallisation des trous (PTH)
 - Surface avec Ni/Au chimique et un laque d'arrêt de soudure
 - Platine d'adaptation pour SO 8
 - Pitch: 1,27 mm (153 mil)
 - Perforation 1,00 mm Ø
 - Dimensions 20,32 x 7,94 mm
- Module-No. Pitch mil Pin Dimensions (mm)

RE932-01 1,270 mm 0,50 8 3,90 (153 mil)



RE932-01

- Fibra de vidrio epoxídica FR4 1,50 mm
 - Por dos lados 35 µm de Cu
 - Agujeros con contactos metalizados (PTH)
 - Superficie terminal química de Ni/Au y una máscara de inhibidora de la soldadura
 - Adaptador para SO 8
 - Pitch: 1,27 mm (153 mil)
 - Diámetro de agujeros 1,00 mm
 - Tamaño 20,32 x 7,94 mm
- Módulo-No. Pitch mil Pin Tamaño (mm)
RE932-01 1,270 mm 0,50 8 3,90 (153 mil)